



# BTA08, BTB08 and T8 Series

SNUBBERLESSTM, LOGIC LEVEL & STANDARD

8A TRIACs

**Table 1: Main Features**

Symbol	Value	Unit
$I_{T(RMS)}$	8	A
$V_{DRM}/V_{RRM}$	600 and 800	V
$I_{GT}(Q_1)$	5 to 50	mA

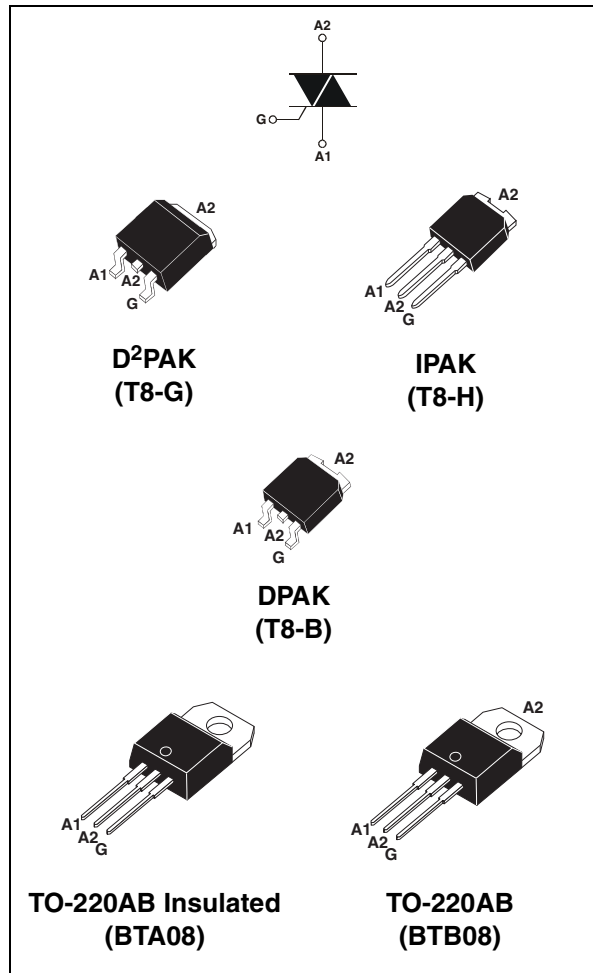
## DESCRIPTION

Available either in through-hole or surface-mount packages, the **BTA08**, **BTB08** and **T8** triac series is suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits... or for phase control operation in light dimmers, motor speed controllers,...

The snubberless versions (BTA/BTB...W and T8 series) are specially recommended for use on inductive loads, thanks to their high commutation performances.

Logic level versions are designed to interface directly with low power drivers such as microcontrollers.

By using an internal ceramic pad, the BTA series provides voltage insulated tab (rated at 2500V<sub>RMS</sub>) complying with UL standards (file ref.: E81734).



**Table 2: Order Codes**

Part Number	Marking
BTA08-xxxxxRG	See page table 8 on page 10
BTB08-xxxxxRG	
T8xx-xxxG	
T8xx-xxxH	
T8xx-xxxB	

## BTA08, BTB08 and T8 Series

**Table 3: Absolute Maximum Ratings**

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	RMS on-state current (full sine wave)	IPAK/D <sup>2</sup> PAK/ DPAK/TO-220AB	$T_c = 110^\circ\text{C}$	8	A
		TO-220AB Ins.	$T_c = 100^\circ\text{C}$		
$I_{TSM}$	Non repetitive surge peak on-state current (full cycle, $T_j$ initial = $25^\circ\text{C}$ )	F = 50 Hz	t = 20 ms	80	A
		F = 60 Hz	t = 16.7 ms	84	
$I^2t$	$I^2t$ Value for fusing	$t_p = 10$ ms		36	A <sup>2</sup> s
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$ , $t_r \leq 100$ ns	F = 120 Hz	$T_j = 125^\circ\text{C}$	50	A/ $\mu\text{s}$
$I_{GM}$	Peak gate current	$t_p = 20$ $\mu\text{s}$	$T_j = 125^\circ\text{C}$	4	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125^\circ\text{C}$	1	W
$T_{stg}$ $T_j$	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	$^\circ\text{C}$

**Tables 4: Electrical Characteristics** ( $T_j = 25^\circ\text{C}$ , unless otherwise specified)

■ **SNUBBERLESS and Logic Level (3 quadrants)**

Symbol	Test Conditions	Quad-rant		T8		BTA08 / BTB08				Unit
				T810	T835	TW	SW	CW	BW	
$I_{GT}$ (1)	$V_D = 12$ V $R_L = 30$ $\Omega$	I - II - III	MAX.	10	35	5	10	35	50	mA
$V_{GT}$		I - II - III	MAX.	1.3						V
$V_{GD}$	$V_D = V_{DRM}$ $R_L = 3.3$ k $\Omega$ $T_j = 125^\circ\text{C}$	I - II - III	MIN.	0.2						V
$I_H$ (2)	$I_T = 100$ mA		MAX.	15	35	10	15	35	50	mA
$I_L$	$I_G = 1.2$ $I_{GT}$	I - III	MAX.	25	50	10	25	50	70	mA
		II		30	60	15	30	60	80	
dV/dt (2)	$V_D = 67\%$ $V_{DRM}$ gate open $T_j = 125^\circ\text{C}$		MIN.	40	400	20	40	400	1000	V/ $\mu\text{s}$
(dI/dt) <sub>c</sub> (2)	$(dV/dt)_c = 0.1$ V/ $\mu\text{s}$ $T_j = 125^\circ\text{C}$		MIN.	5.4	-	3.5	5.4	-	-	A/ms
	$(dV/dt)_c = 10$ V/ $\mu\text{s}$ $T_j = 125^\circ\text{C}$			2.8	-	1.5	2.98	-	-	
	Without snubber $T_j = 125^\circ\text{C}$			-	4.5	-	-	4.5	7	

■ Standard (4 quadrants)

Symbol	Test Conditions	Quadrant		BTA08 / BTB08		Unit
				C	B	
$I_{GT}$ (1)	$V_D = 12\text{ V}$ $R_L = 30\ \Omega$	I - II - III IV	MAX.	25 50	50 100	mA
$V_{GT}$		ALL	MAX.	1.3		V
$V_{GD}$	$V_D = V_{DRM}$ $R_L = 3.3\text{ k}\Omega$ $T_j = 125^\circ\text{C}$	ALL	MIN.	0.2		V
$I_H$ (2)	$I_T = 500\text{ mA}$		MAX.	25	50	mA
$I_L$	$I_G = 1.2 I_{GT}$	I - III - IV	MAX.	40	50	mA
		II		80	100	
dV/dt (2)	$V_D = 67\% V_{DRM}$ gate open $T_j = 125^\circ\text{C}$		MIN.	200	400	V/ $\mu\text{s}$
(dV/dt) <sub>c</sub> (2)	$(di/dt)_c = 5.3\text{ A/ms}$ $T_j = 125^\circ\text{C}$		MIN.	5	10	V/ $\mu\text{s}$

Table 5: Static Characteristics

Symbol	Test Conditions			Value	Unit	
$V_T$ (2)	$I_{TM} = 11\text{ A}$	$t_p = 380\ \mu\text{s}$	$T_j = 25^\circ\text{C}$	MAX.	1.55	V
$V_{to}$ (2)	Threshold voltage		$T_j = 125^\circ\text{C}$	MAX.	0.85	V
$R_d$ (2)	Dynamic resistance		$T_j = 125^\circ\text{C}$	MAX.	50	m $\Omega$
$I_{DRM}$ $I_{RRM}$	$V_{DRM} = V_{RRM}$		$T_j = 25^\circ\text{C}$	MAX.	5	$\mu\text{A}$
			$T_j = 125^\circ\text{C}$		1	mA

Note 1: minimum  $I_{GT}$  is guaranteed at 5% of  $I_{GT}$  max.

Note 2: for both polarities of A2 referenced to A1.

Table 6: Thermal resistance

Symbol	Parameter		Value	Unit	
$R_{th(j-c)}$	Junction to case (AC)		I <sub>PAK</sub> / D <sup>2</sup> PAK / DPAK / TO-220AB	1.6	$^\circ\text{C/W}$
			TO-220AB Insulated	2.5	
$R_{th(j-a)}$	Junction to ambient	S = 1 cm <sup>2</sup>	D <sup>2</sup> PAK	45	$^\circ\text{C/W}$
		S = 0.5 cm <sup>2</sup>	DPAK	70	
			TO-220AB / TO-220AB Insulated	60	
			I <sub>PAK</sub>	100	

S = Copper surface under tab.

Figure 1: Maximum power dissipation versus RMS on-state current (full cycle)

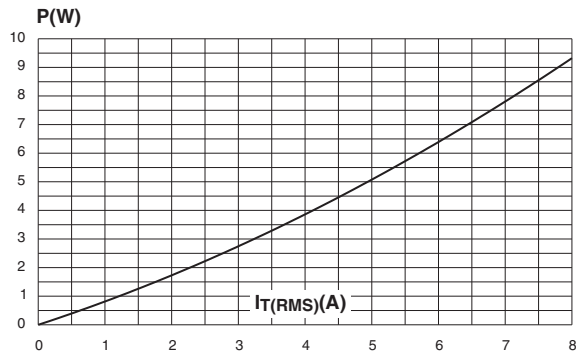


Figure 2: RMS on-state current versus case temperature (full cycle)

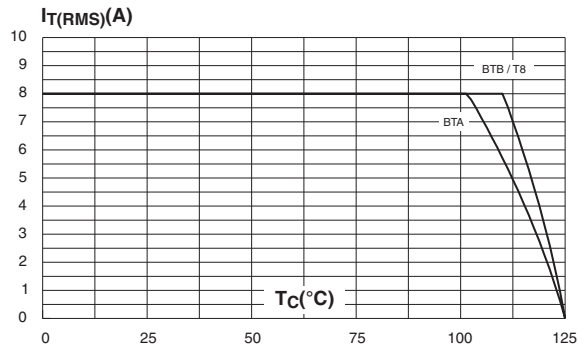


Figure 3: RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35µm) (full cycle)

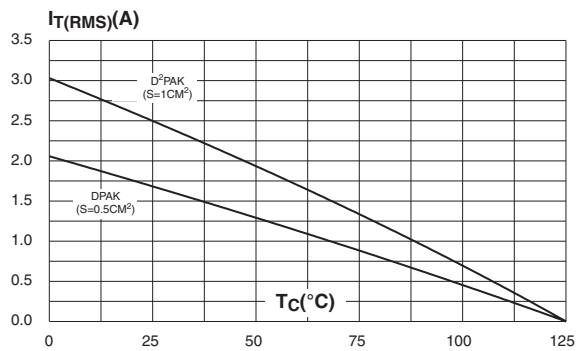


Figure 4: Relative variation of thermal impedance versus pulse duration

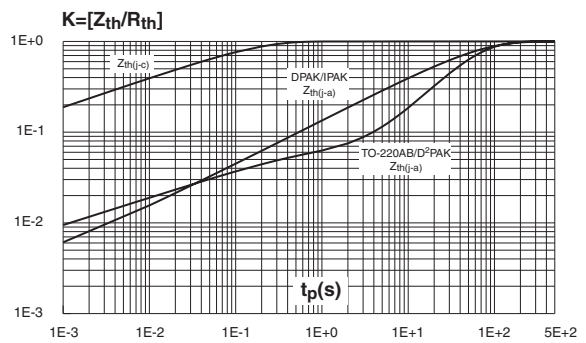


Figure 5: On-state characteristics (maximum values)

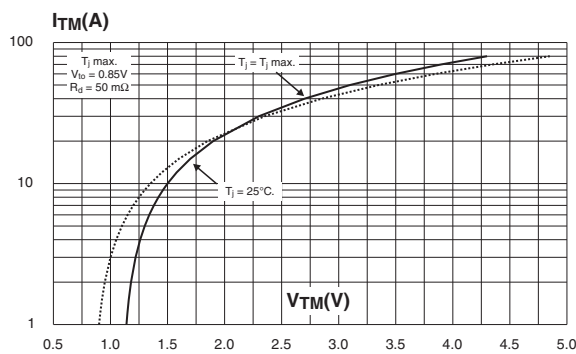


Figure 6: Surge peak on-state current versus number of cycles

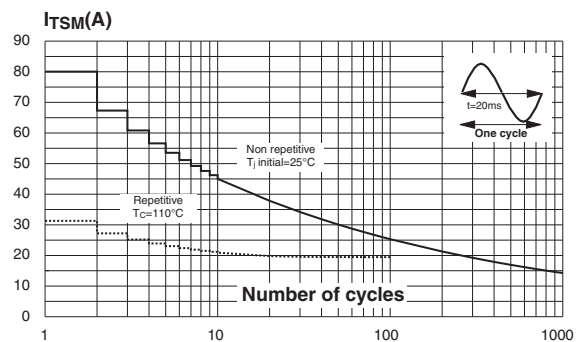


Figure 7: Non-repetitive surge peak on-state current for a sinusoidal pulse with width  $t_p < 10$  ms and corresponding value of  $I^2t$

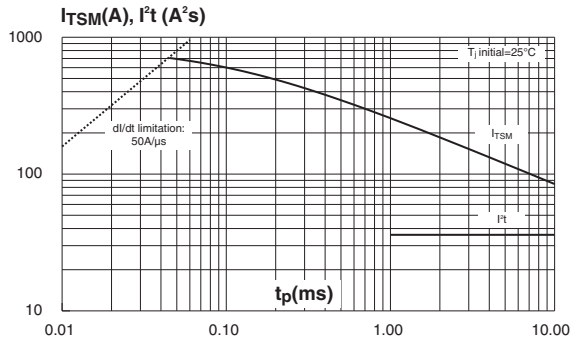


Figure 8: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values)

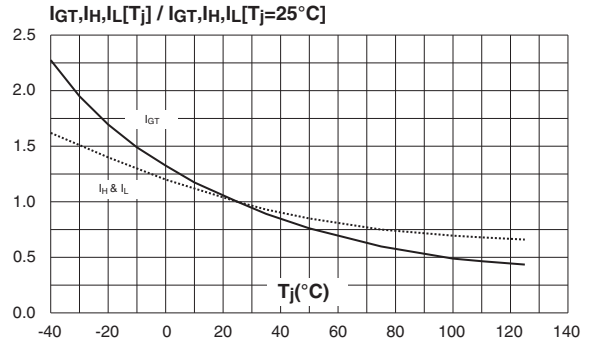


Figure 9: Relative variation of critical rate of decrease of main current versus  $(dV/dt)_c$  (typical values) (Snubberless & Logic level types)

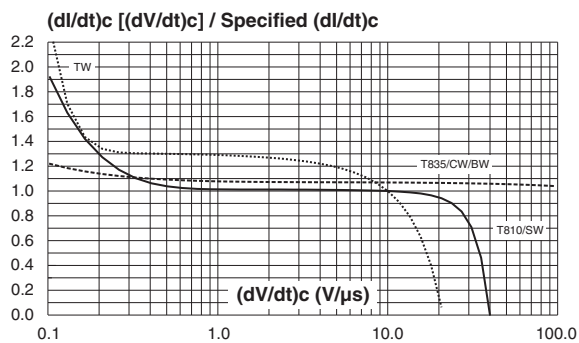


Figure 10: Relative variation of critical rate of decrease of main current versus  $(dV/dt)_c$  (typical values) (Standard types)

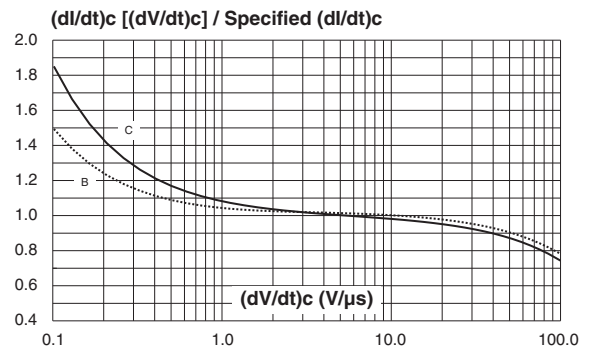


Figure 11: Relative variation of critical rate of decrease of main current versus junction temperature

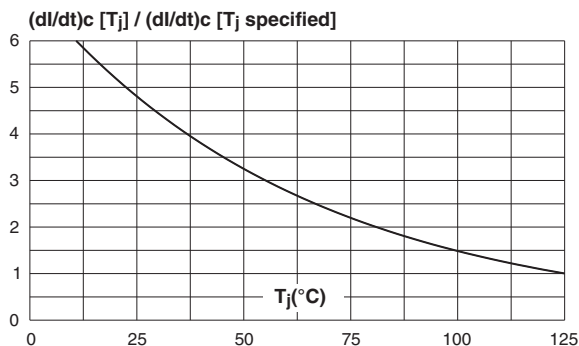
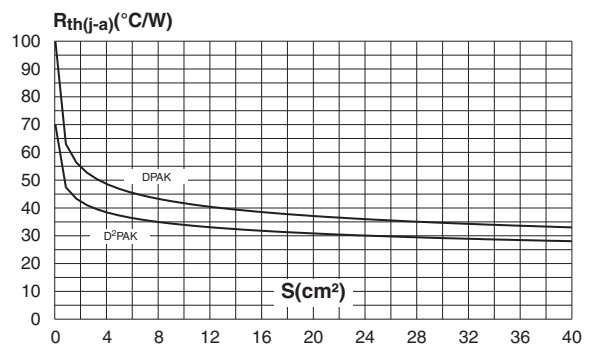


Figure 12: DPAK and D<sup>2</sup>PAK Thermal resistance junction to ambient versus copper surface under tab (printed circuit board FR4, copper thickness: 35  $\mu$ m)



## BTA08, BTB08 and T8 Series

Figure 13: Ordering Information Scheme (BTA08 and BTB08 series)

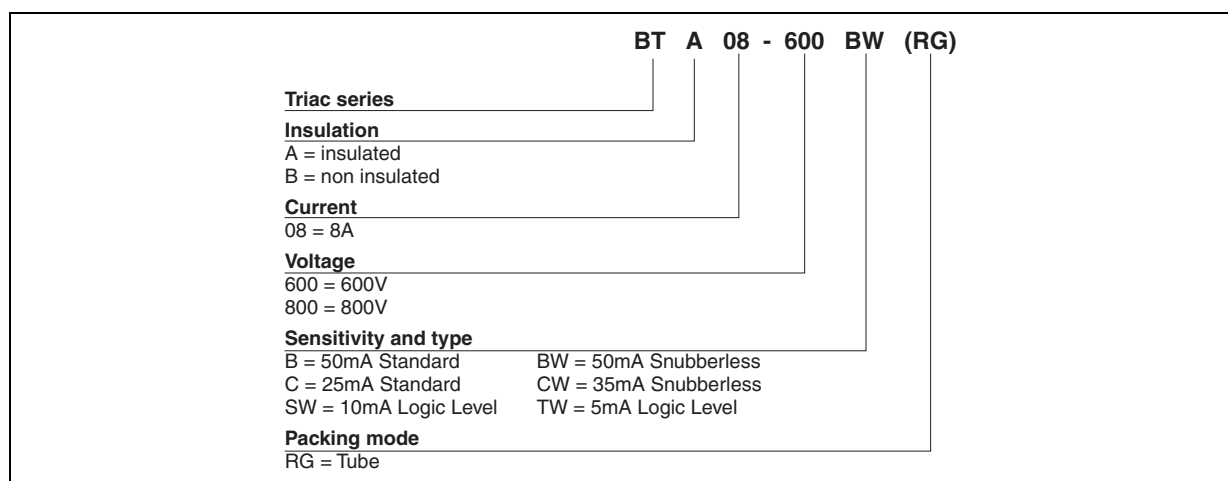


Figure 14: Ordering Information Scheme (T8 series)

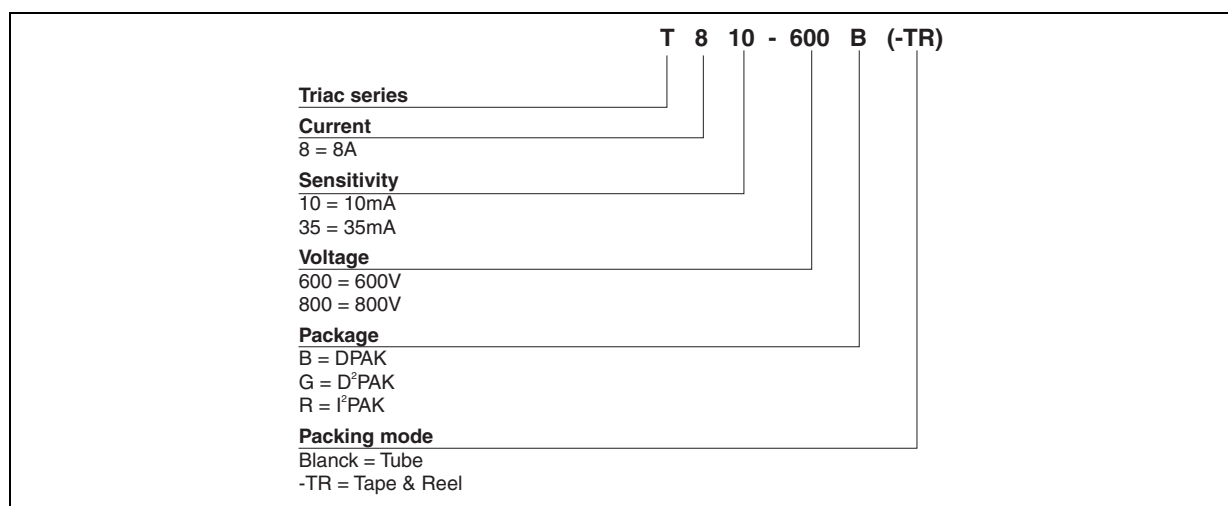


Table 7: Product Selector

Part Number	Voltage (xxx)		Sensitivity	Type	Package
	600 V	800 V			
BTA/BTB08-xxxB	X	X	50 mA	Standard	TO-220AB
BTA/BTB08-xxxBW	X	X	50 mA	Snubberless	TO-220AB
BTA/BTB08-xxxC	X	X	25 mA	Standard	TO-220AB
BTA/BTB08-xxxCW	X	X	35 mA	Snubberless	TO-220AB
BTA/BTB08-xxxSW	X	X	10 mA	Logic level	TO-220AB
BTA/BTB08-xxxTW	X	X	5 mA	Logic Level	TO-220AB
T810-xxxG	X	X	10 mA	Logic Level	D <sup>2</sup> PAK
T810-xxxH	X	X	10 mA	Logic Level	IPAK
T835-xxxB	X	X	35 mA	Snubberless	DPAK
T835-xxxG	X	X	35 mA	Snubberless	D <sup>2</sup> PAK
T835-xxxH	X	X	35 mA	Snubberless	IPAK

**BTB:** non insulated TO-220AB package

Figure 15: D<sup>2</sup>PAK Package Mechanical Data

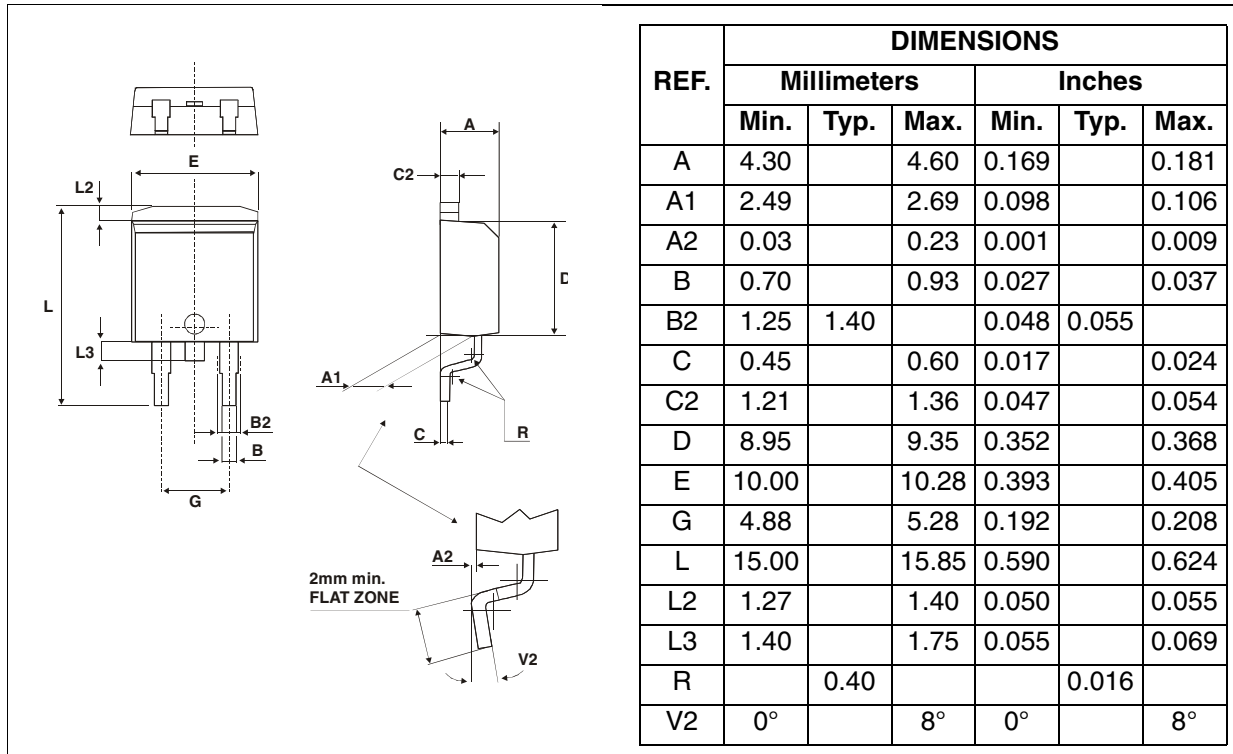


Figure 16: D<sup>2</sup>PAK Foot Print Dimensions (in millimeters)

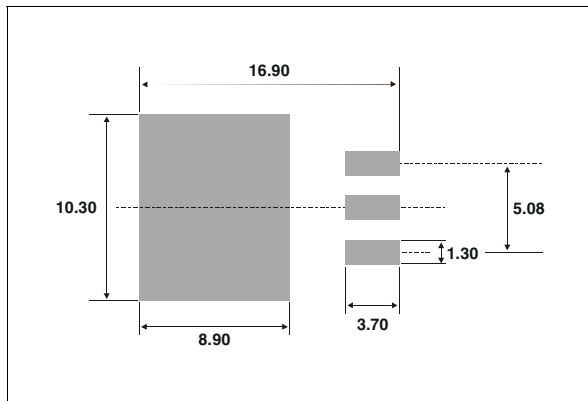


Figure 17: DPAK Package Mechanical Data

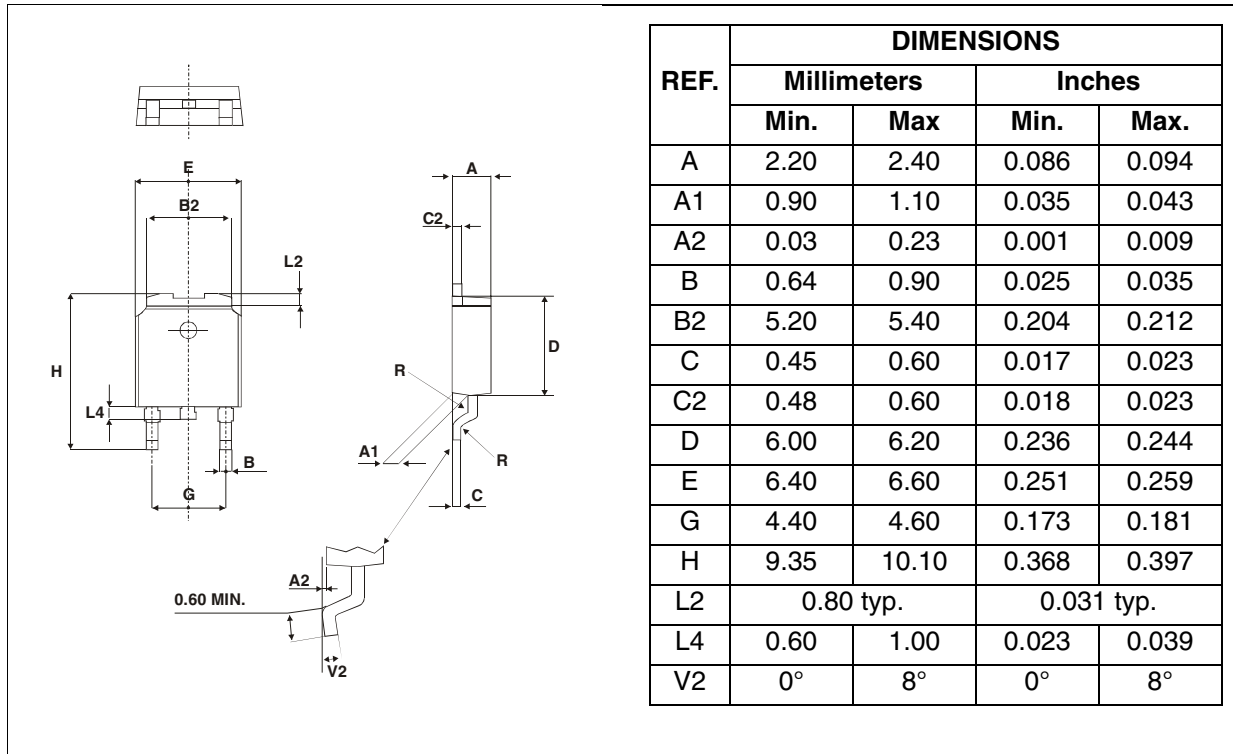


Figure 18: DPAK Foot Print Dimensions (in millimeters)

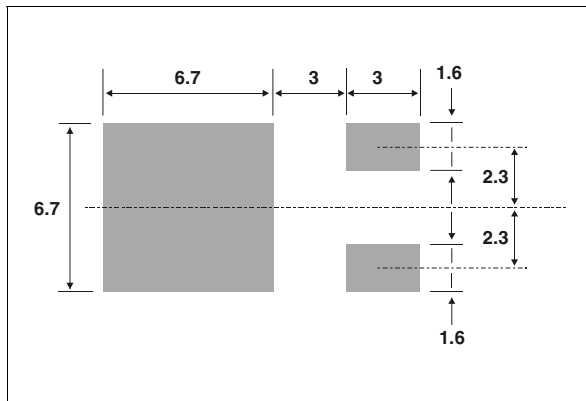




Figure 19: TO-220AB Package Mechanical Data

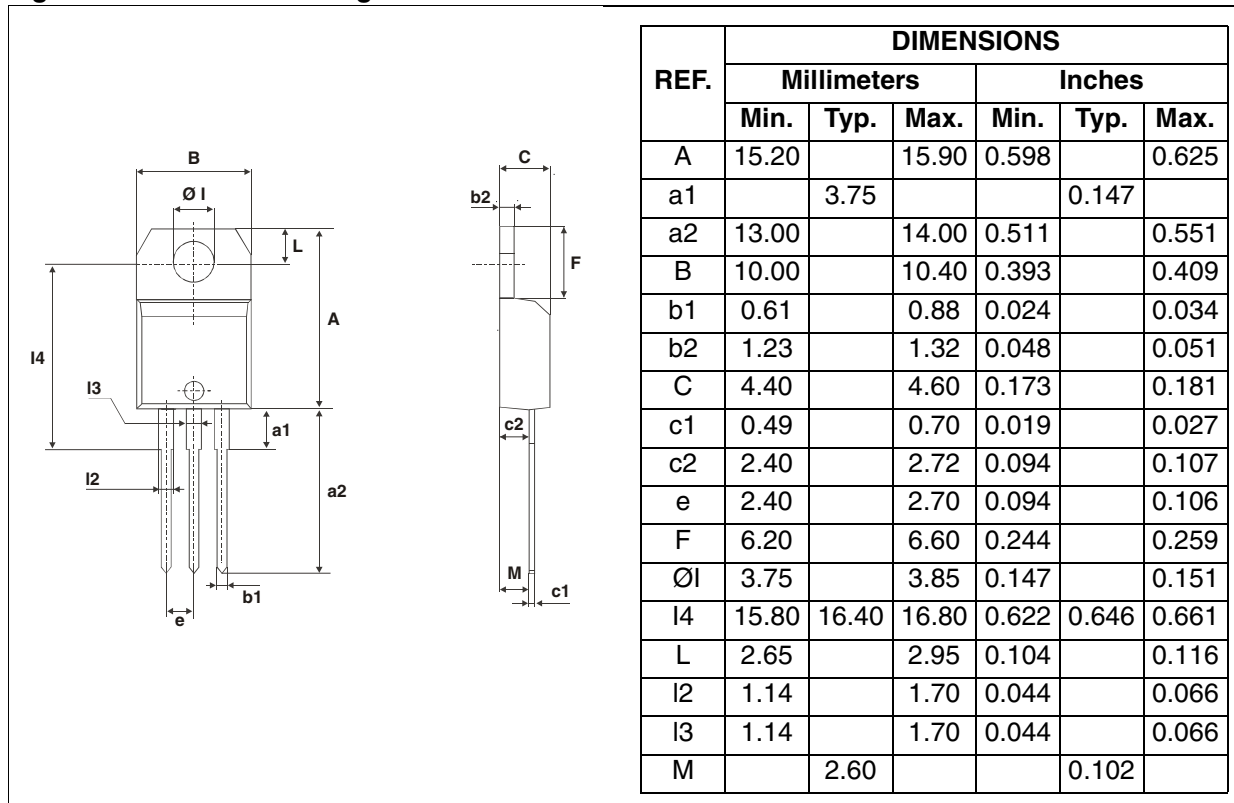
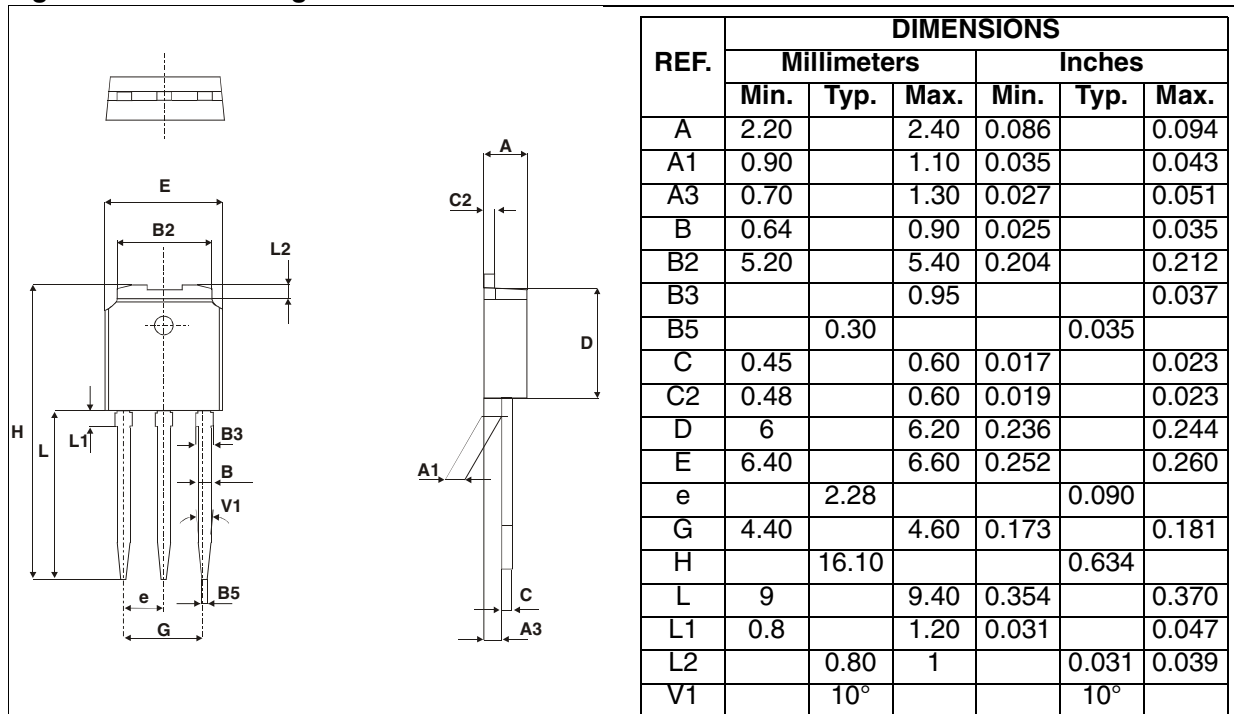


Figure 20: IPAK Package Mechanical Data



## BTA08, BTB08 and T8 Series

---

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com).

**Table 8: Ordering Information**

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
BTA/BTB08-xxxzyRG	BTA/BTB08-xxxzy	TO-220AB	2.3 g	50	Tube
T8yy-xxxG	T8yyxx	D <sup>2</sup> PAK	1.5 g	50	Tube
T8yy-xxxG-TR	T8yyxx			1000	Tape & reel
T8yy-xxxB	T8yyxx	DPAK	0.3 g	75	Tube
T8yy-xxxB-TR	T8yyxx			2500	Tape & reel
T8yy-xxxH	T8yyxx	IPAK	0.4 g	75	Tube

**Note:** xxx = voltage, yy = sensitivity, z = type

**Table 9: Revision History**

Date	Revision	Description of Changes
Apr-2002	5A	Last update.
13-Feb-2006	6	TO-220AB delivery mode changed from bulk to tube. ECOPACK statement added.

Information furnished is believed to be accurate and reliable. However, STMicroelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of STMicroelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. STMicroelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of STMicroelectronics.

The ST logo is a registered trademark of STMicroelectronics.  
All other names are the property of their respective owners

© 2006 STMicroelectronics - All rights reserved

**STMicroelectronics group of companies**

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -  
Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America  
[www.st.com](http://www.st.com)

